IDWD10G120C5



5th Generation CoolSiC[™] 1200V Schottky Diode

SiC Diode

Features

- No reverse recovery current / no forward recovery
- High surge current capability
- Temperature independent switching behaviour
- Low forward voltage even at high operating temperature
- Tight forward voltage distribution
- Specified dv/dt ruggedness
- Pb-free lead plating; RoHS compliant

Potential applications

- Industrial power supplies: Industrial UPS
- Infrastructure-Charge: Charger
- Metal treatment: Welding
- Solar central inverters, Solar string inverter and Solar optimizer

Product validation

Qualified for industrial applications according to the relevant tests of JEDEC 47/20/22

Description

- System efficiency improvement over Si diodes
- Enabling higher frequency / increased power density solutions
- System size/cost savings due to reduced heatsink requirements and smaller magnetics
- Reduced EMI
- Highest efficiency across the entire load range
- Robust diode operation during surge events
- High reliability
- Related Links: <u>www.infineon.com/SiC</u>





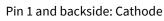


Туре	V _{DC}	IF	Qc	T _{vj,max}	Marking	Package
IDWD10G120C5	1200 V	10 A	57nC	175°C	D1012C5	PG-T0247-2



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20



Pin 2: Anode



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Maximum ratings

1 Maximum ratings

Note:

For optimum lifetime and reliability, Infineon recommends operating conditions that do not exceed 80% of the maximum ratings stated in this datasheet.

Parameter	Symbol	Value	Unit
Repetitive peak reverse voltage $T_{\rm C} \ge 25^{\circ}{\rm C}$	V _{RRM}	1200	V
Continuous forward current for $R_{th(j-c,max)}$ $T_c = 156^{\circ}C, D=1$ $T_c = 135^{\circ}C, D=1$ $T_c = 25^{\circ}C, D=1$	/ _F	10 16 34	A
Surge repetitive forward current, sine halfwave ¹ <i>T</i> _c =25°C, t _p =10ms <i>T</i> _c =100°C, t _p =10ms	I _{F,RM}	40 30	A
Surge non-repetitive forward current, sine halfwave $T_c=25^{\circ}C$, $t_p=10ms$ $T_c=150^{\circ}C$, $t_p=10ms$	I _{F,SM}	140 130	A
Non-repetitive peak forward current <i>T</i> _c = 25°C, <i>t</i> _p =10 μs	I _{F,max}	1070	A
i ² t value $T_{c} = 25^{\circ}C, t_{p}=10 \text{ ms}$ $T_{c} = 150^{\circ}C, t_{p}=10 \text{ ms}$	∫i²dt	98 84	A ² s
Diode dv/dt ruggedness V _R =0960 V	dv/dt	150	V/ns
Power dissipation for $R_{th(j-c,max)}$ $T_c = 25^{\circ}C$	P _{tot}	148	w

¹ Not subject to production test. The test was performed with 20000 pulses (two consecutive half-wave rectified sines with 10 ms period). Datasheet Please read the Important Notice and Warnings at the end of this document V2

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Maximum ratings

Operating temperature	T _{vj}	-55175	°C
Storage temperature	$T_{\rm stg}$	-55150	°C
Soldering temperature, wave soldering only allowed at leads 1.6mm (0.063 in.) from case for 10 s	T _{sold}	260	°C
Mounting torque, M3 screw Maximum of mounting processes: 3	М	0.6	Nm



Thermal resistances

Thermal resistances 2

Parameter	Cumhal	Conditions	Value			Unit
Parameter	Symbol		min.	typ.	max.	Unit
Characteristic						
Diode thermal resistance, junction – case	R _{th(j-c)}		-	0.8	1.0	K/W
Thermal resistance, junction – ambient	$R_{th(j-a)}$	leaded	-	-	62	K/W



Electrical Characteristics

Electrical Characteristics 3

Static Characteristics, at T_{vj} =25°C, unless otherwise specified

Daramatar	Symbol	Conditions	Value			Unit
Parameter			min.	typ.	max.	Unit
DC blocking voltage	V _{DC}	<i>T_{vj}</i> =25°C, I _R =500μA	1200	-	-	V
Diode forward voltage	V _F	<i>I</i> _F = 10A, <i>T</i> _{vj} =25°C	-	1.4	1.65	V
		<i>I</i> _F = 10A, <i>T</i> _{vj} =150°C	-	1.7	-	
Reverse current	I _R	V _R =1200V, <i>T_{vj}</i> =25°C	-	6	80	μA
		<i>V</i> _R =1200V, <i>T</i> _{vj} =150°C	-	28	-	

Dynamic Characteristics, at $T_{\nu j}$ =25°C, unless otherwise specified

Parameter	Symbol	Conditions	Value			Unit
			min.	typ.	max.	Ome
Total capacitive charge		<i>V</i> _R = 800V, <i>T</i> _{vj} =150°C & 25°C				
	Qc	$Q_C = \int_0^{V_R} C(V) dV$	-	57	-	nC
		<i>V</i> _R =1 V, <i>f</i> =1 MHz	-	730	-	
Total Capacitance	С	<i>V</i> _R =400 V, <i>f</i> =1 MHz	-	51	-	pF
		<i>V</i> _R =800 V, <i>f</i> =1 MHz	-	41	-	



4 Electrical Characteristics Diagrams

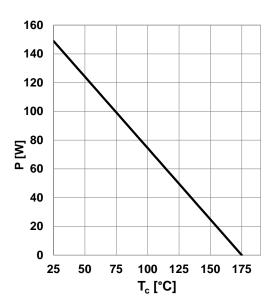


Figure 1. Power dissipation as function of case temperature, P_{tot} =f(TC), $R_{th(j-c),max}$

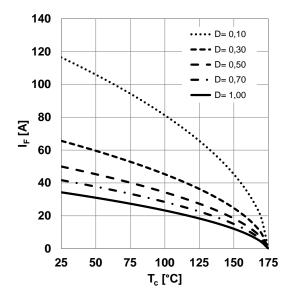


Figure 2. Diode forward current as function of temperature, parameter: $T_{vj} \leq 175^{\circ}$ C, $R_{th(j)}$. c),max, D=duty cycle, V_{th} , R_{diff} @ T_{vj} =175°C

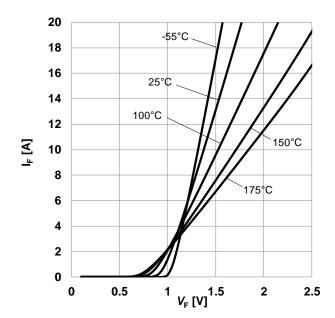


Figure 3. Typical forward characteristics, $I_F=f(V_F)$, $t_p=10 \mu s$, parameter: T_{vj}

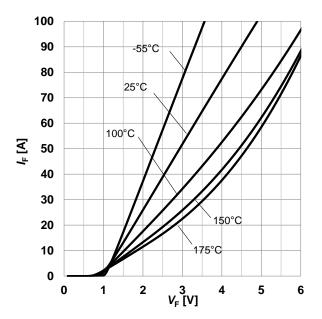
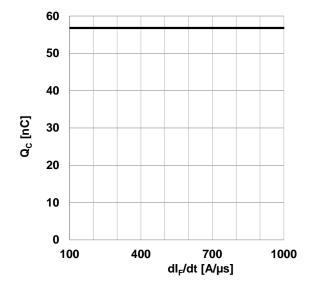


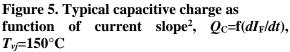
Figure 4. Typical forward characteristics in surge current, $I_F=f(V_F)$, $t_p=10 \mu s$, parameter: T_{vj}

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Electrical Characteristics Diagrams





2) guaranteed by design

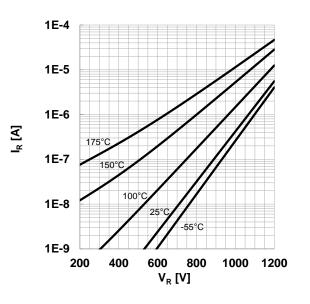


Figure 6. Typical reverse characteristics, $I_R=f(V_R)$, parameter: $T_{\nu j}$

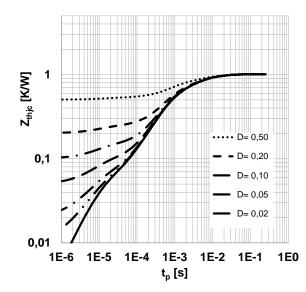


Figure 7. Max. transient thermal impedance, Z_{th,j-c}=f(tP), parameter: D=tP/T

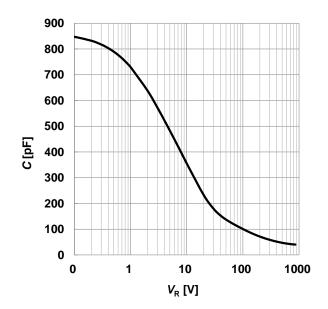


Figure 8. Typical capacitance as function of reverse voltage, C=f(VR); T_{vj} =25°C; f=1 MHz

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Electrical Characteristics Diagrams

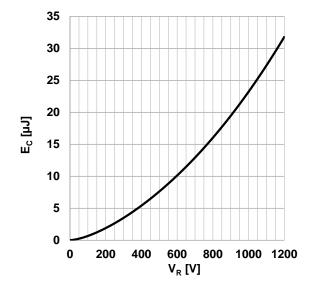
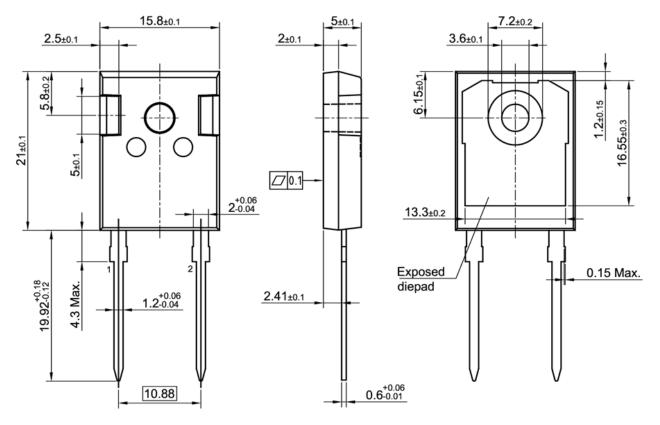


Figure 9. Typical capacitively stored energy as function of reverse voltage, $E_{\rm C}$ =f($V_{\rm R}$)



5 Package Drawing

PG-TO247-2



5th Generation CoolSiC[™] 1200V Schottky Diode SiC-Diode Revision history



Revision history

Document version	Date of release	Description of changes
V 1.0	2018-12-21	Preliminary Datasheet
V 2.0	2019-01-30	Final Datasheet
V 2.1	2021-03-01	Increased dv/dt ruggedness

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Document reference

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